MOSFET - Power, Single **N-Channel, TOLL**

40 V, 1.21 mΩ, 240 A

FDBL9406-F085T6

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
40 V	1.21 mΩ @ 10 V	240 A		

MAXIMUM RATINGS (T _J = 25° C unless otherwise noted)								
Parameter			Symbol	Value	Unit			
Drain-to-Source Voltage			V _{DSS}	40	V			
Gate-to-Source Voltage			V _{GS}	+20/-16	V			
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	I _D	240	А			
Current $R_{\theta JC}$ (Note 2)		$T_{C} = 100^{\circ}C$	1	179.4				
Power Dissipation		$T_{C} = 25^{\circ}C$	PD	136.4	W			
R _{θJC} (Note 2)		$T_{C} = 100^{\circ}C$	1	68.2				
Continuous Drain	Steady State	T _A = 25°C	I _D	45	А			
Current R _{θJA} (Notes 1, 2)		T _A = 100°C		31.8				
Power Dissipation		State	$T_A = 25^{\circ}C$	P _D	4.3	W		
R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$	1	2.1				
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	2817	А			
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C			
Source Current (Body Diode)			۱ _S	221	А			
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 42.5 A)			E _{AS}	271	mJ			
Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s)			ΤL	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

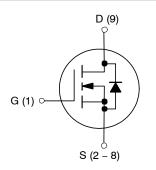
THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	1.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	35	

1. Surface-mounted on FR4 board using a 1 in² pad size, 1 oz. Cu pad.

2. The entire application environment impacts the thermal resistance values shown,

they are not constants and are only valid for the particular conditions noted.





CASE 100CU

ORDERING INFORMATION

Device	Device Package	
FDBL9406-F085T6	H-PSOF8L (Pb-Free)	2000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Table 1. ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conc	litions	Min	Тур	Max	Units
OFF CHARACTERISTICS	•			•			
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I_{D} = 250 µA, V_{GS} = 0 V			24.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 40 V, V_{GS} = 0 V	$T_J = 25^{\circ}C$			10	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= +20/-16 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_{D}$	₀ = 190 μA	2	2.8	3.5	V
Negative Threshold Temperature Coefficient	V _{GS(th)} /T _J				-6.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,	I _D = 50 A		1.1	1.21	mΩ
Forward Transconductance	9 FS	V _{DS} = 15 V, I	l _D = 50 A		143		S
CHARGES & CAPACTIANCES					-	-	-
Input Capacitance	C _{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz			4960		pF
Output Capacitance	C _{oss}				2800		pF
Reverse Transfer Capacitance	C _{rss}				62		pF
Total Gate Charge	Q _{G(tot)}	$V_{GS} = 10 \text{ V}, V_{DS} = 20 \text{ V},$ $I_D = 50 \text{ A}$			75		nC
Threshold Gate Charge	Q _{G(th)}				9		nC
Gate-to-Source Charge	Q _{gs}				22		nC
Gate-to-Drain Charge	Q _{gd}				16		nC
SWITCHING CHARACTERISTICS, $V_{GS} = 10$	0 V (Note 3)				-	-	-
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10 V, V			27		ns
Rise Time	t _r	- I _D = 50 A, R _G = 6 Ω			44		ns
Turn–Off Delay Time	t _{d(off)}				61		ns
Fall Time	t _f				26		ns
DRAIN-SOURCE DIODE CHARACTERIST	CS			-	-	-	-
Forward Diode Voltage	V _{SD}	$I_{\rm S}$ = 50 A, $V_{\rm GS}$ = 0 V	$T_J = 25^{\circ}C$		0.8	1.2	V
		$I_{\rm S}$ = 50 A, $V_{\rm GS}$ = 0 V	T _J = 125°C		0.6		V
Reverse Recovery Time	t _{rr}	V_{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 50 A			78		ns
Charge Time	ta				39		ns

Reverse Recovery Charge Q_{rr} Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Switching characteristics are independent of operating junction temperatures

39

101

ns

ns

nC

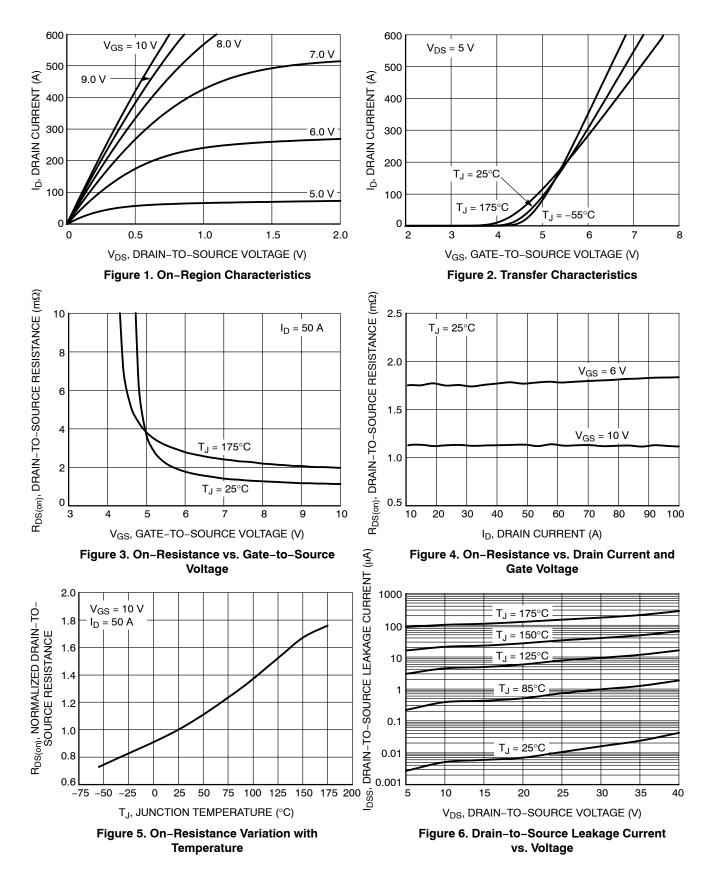
ta

tb

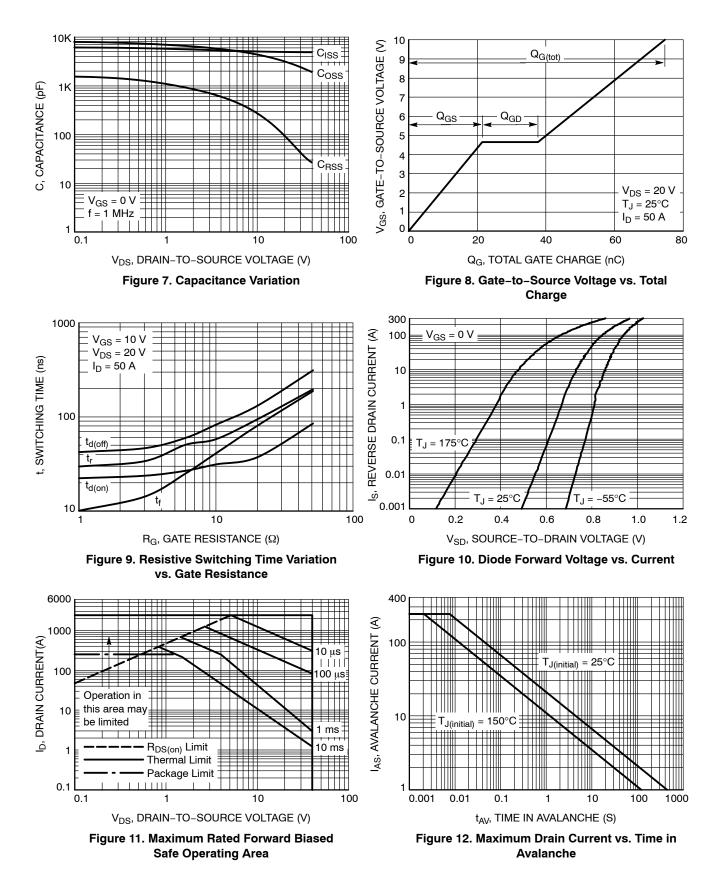
Charge Time

Discharge Time

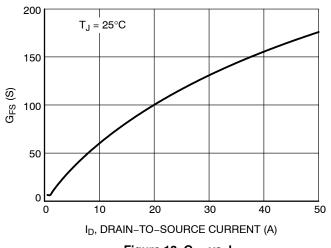
TYPICAL CHARACTERISTICS

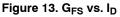


TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





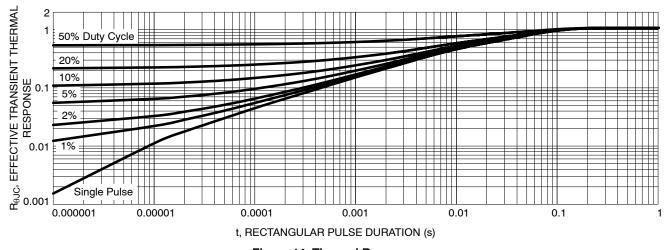
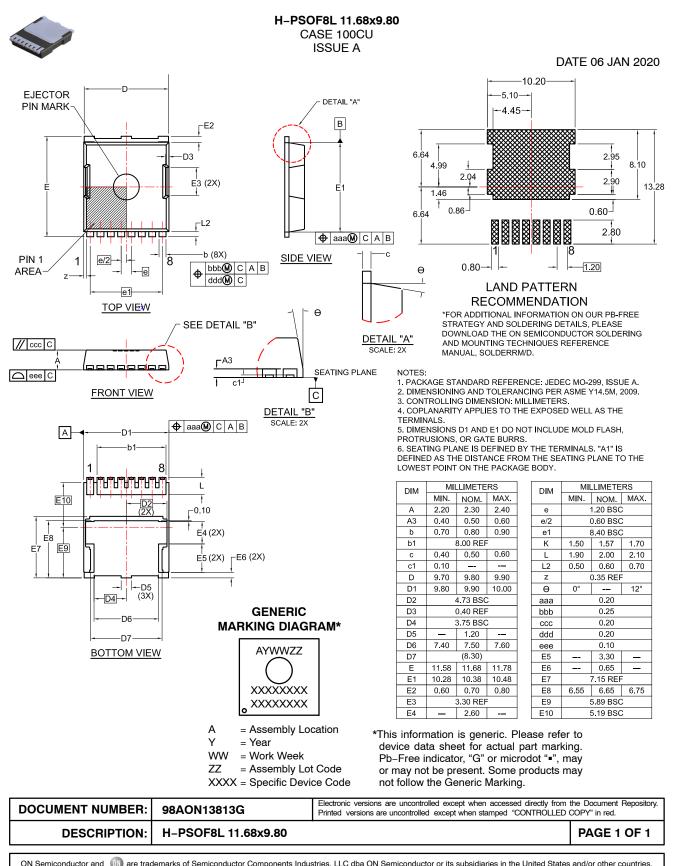


Figure 14. Thermal Response





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